

# Product data sheet

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#### **Specification Features:**

- Ultra Low Capacitance 0.5 pF
- Low Clamping Voltage
- Small Body Outline Dimensions: 0.039" x 0.024" (1.00 mm x 0.60 mm)
- Low Body Height: 0.016" (0.4 mm)
- Stand-off Voltage: 5 V
- Low Leakage
- Response Time is Typically < 1.0 ns
- IEC61000-4-2 Level 4 ESD Protection
- This is a Pb–Free Device
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.



Semiconductor

ESD9X5.0ST5G-MS



Compiance

PIN 1. CATHODE 2. ANODE

SOD-923

#### ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted, VF = 1.0 V Max. @ IF = 10 mA for all types)

	V <sub>RWM</sub> (V)	Ι <sub>R</sub> (μΑ) @ V <sub>RWM</sub>	V <sub>BR</sub> (V) @ I <sub>T</sub> (Note 2)	Іт	с	(pF)	Vc (V) @ IPP = 1 A (Note 3)	Vc
P/N	Max	Мах	Min	mA	Тур	Max	Мах	Per IEC61000-4-2 (Note 4)
ESD9X5.0ST5G-MS	5.0	1.0	5.4	1.0	15	15	9.8	Figures 1 and 2 See Below

2. VBR is measured with a pulse test current IT at an ambient temperature of 25°C.

3. Surge cuprent waveform pgerFigure 5.

4. For test rocedure see Fi ures 3 and 4.

#### **ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub> = 25°C unless otherwise noted)

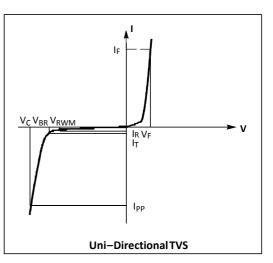
Symbol	Parameter			
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current			
Vc	Clamping Voltage @ IPP			
V <sub>RWM</sub>	Working Peak Reverse Voltage			
IR	Maximum Reverse Leakage Current @ VRWM			
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>			
Ιτ	Test Current			
lF	Forward Current			
VF	Forward Voltage @ IF			
P <sub>pk</sub>	Peak Power Dissipation			
С	Capacitance @ $V_R$ = 0 and f = 1.0 MHz			

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
IEC 61000-4-2 (ESD) Contact Air		±10 ±15	kV	
Total Power Dissipation on FR-5 Board (Note 1) @ $T_A = 25^{\circ}C$	PD	150	mW	
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C	
Junction Temperature Range	Tj	-55 to +125	°C	
Lead Solder Temperature – Maximum (10 Second Duration)	ΤL	260	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

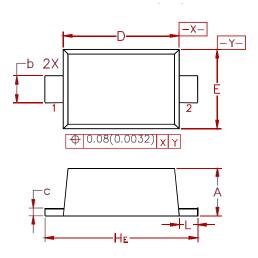
1. FR-5 = 1.0 x 0.75 x 0.62 in.





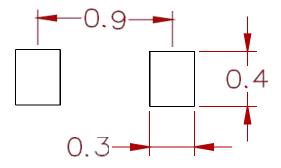
ESD9X5.0ST5G-MS

## PACKAGE MECHANICAL DATA



<b>D</b> :		Millimeters		Inches			
Dim	Min	Nom	Max	Min	Nom	Max	
A	0.36	0.40	0.43	0.014	0.016	0.017	
b	0.15	0.20	0.25	0.006	0.008	0.010	
С	0.07	0.12	0.17	0.003	0.005	0.007	
D	0.75	0.80	0.85	0.030	0.031	0.033	
E	0.55	0.60	0.65	0.022	0.024	0.026	
HE	0.95	1.00	1.05	0.037	0.039	0.041	
L	0.05	0.10	0.15	0.002	0.004	0.006	

## Suggested Pad Layout



**Dimensions: Millimeters** 

### **REEL SPECIFICATION**

P/N	PKG	QTY
ESD9X5.0ST5G-MS	SOD-923	8000



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